PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3937432

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
IKSANG KIM	06/13/2016
BUMSU PARK	06/13/2016
HYUNJUNE YANG	06/13/2016

RECEIVING PARTY DATA

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PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29567211

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NAME OF SUBMITTER:	SHABNAM NOWROUZI
SIGNATURE:	/Shabnam Nowrouzi/
DATE SIGNED:	06/27/2016
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 2

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PATENT REEL: 039021 FRAME: 0385

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COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-na	amed inventor, I h	ereby declar	e that this declar	ation is direct	ted to the	e application attached hereto, o 29/567.211
	tes Application Nu				noer	
filed on	June 7, 2016	(if 8	ipplicable), entitie	d:		
	K	EYBOARD	COVER FOR	TABLET CO	IMPUTI	ER
The above-id	entified application	was made	or authorized to b	e made by n	ne.	
I believe I am application.	the original inven	tor or an orig	ginal joint invento	r of a claimed	inventi	on in the above-identified
	nowledge that any prisonment of not r				ation is p	ounishable under 18 USC 1001
I have review	red and understan	d the conten	ts of the above-ic	entified appli	ication, i	including the claims.
to be material information the	I to patentability as	defined in total	37 CFR 1.56, incl the filing date of	uding for cor the prior appl	itinuatio	ice all information known to me n-in-part applications, material and the national or PCT
Sam 129,	consideration, I, a sung Electronics C Samsung-ro, Yeo on-si, Gyeonggi-do	lo., Ltd. ngtong-gu	ASSIGNM amed assignor, hi		10:	
	ublic of Korea					
and its succe	ssors and assigns	(collectively	/ hereinafter calle	d "the Assigr	ree"), th	e entire right, title, and interest
throughout th	e world in the inve	entions and i	mprovements the	it are the sub	ject of the	ne application identified in the
			Application Number June 7, 2016		emation	al Application Number
Assignment I	•	the applicat	ion number and t	he filing date	of the a	n to hereafter complete this above-identified application whe signment.
models, and	design registration	is granted fo	or any of the inver	ntions and im	provem	tes and foreign patents, utility ents that are the subject of the of the above-identified

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application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other freaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further

PATENT REEL: 039021 FRAME: 0386

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

compensation to perform such lawful acts and to sign such further applications. Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

inventor's Legal Name	Iksang KIM		
inventor's Signature	IL SANG KIM	Date	13 . Tune, 2016
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	Inventor's Legal Name	Hyunjune YANG	
	Inventor's Signature	Hyun-June Yang Dairo 13, June, 2016	
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